

MILLIMETER DIMENSIONS ARE DERIVED FROM ORIGINAL INCH DIMENSIONS

SYMBOL	INC:	HES	MILLIM MIN.	MAX.	NOTES	ISSUE		
ØD	.190	.205	4.83	5.20	-	A RELEASE NO. 5096		
ØDı	.165	.190	4.20	4.82	-	B RELEASE NO. 50968		
ØΒ	.016	.021	.407	.533	1	C RELEASE NO. 5096C		
ØB ₂	.016	.019	.407	.482	-			
E	.110	.140	2.80	3.55	_			
е	.095	.105	2.42	2.66	-			
eı	.045	.055	1.15	1.39	-			
F	.055	.075	1.40	1.90	-			
G	.200	.265	5.08	6.73	-			
L	.500	_	12.70	-	1			
Lı	- ,	.050	-	1.27	1			
L ₂	.250	-	6.35	-	1			
S	.085	.115	2.16	2.92	-			

NOTES:

1. (THREE LEADS) $\emptyset B_2$ APPLIES BETWEEN L1 AND L2. $\emptyset B$ APPLIES BETWEEN L2 AND .5" (12.70 MM) FROM SEATING PLANE. DIAMETER IS UNCONTROLLED IN L1 AND BEYOND .5" (12.70MM) FROM SEATING PLANE.

JEDEC PUBLICATION	05	OUTLINE	ISSUE	DATE	
OFFICE LOFFICHION	72	TO		LAAI	1070
REGISTERED OUTLINES FOR SEMICONDUCT	OR DEVICES	TO - 98		JAN	19/3